



SPECIFICATIONS

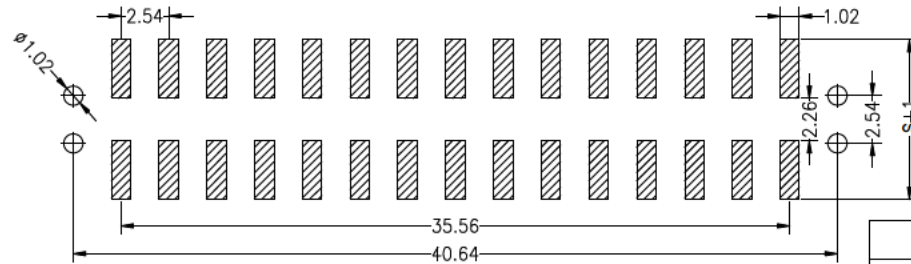
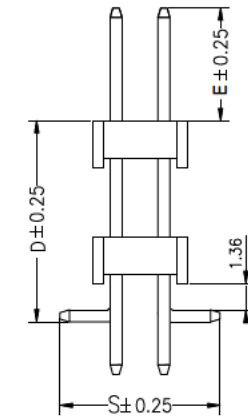
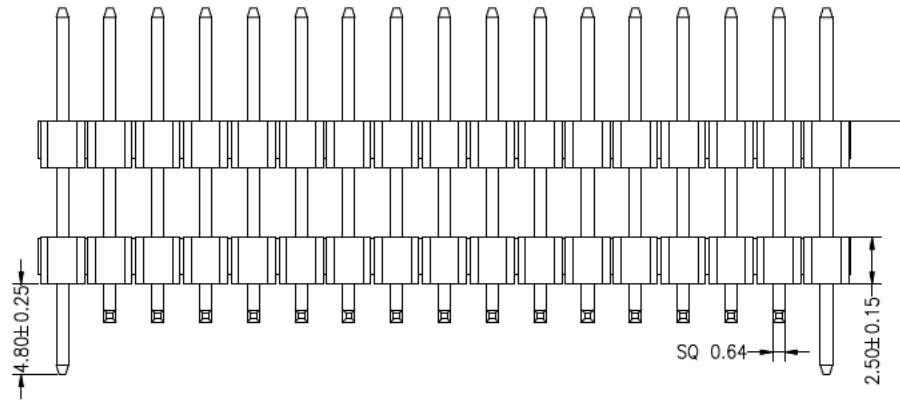
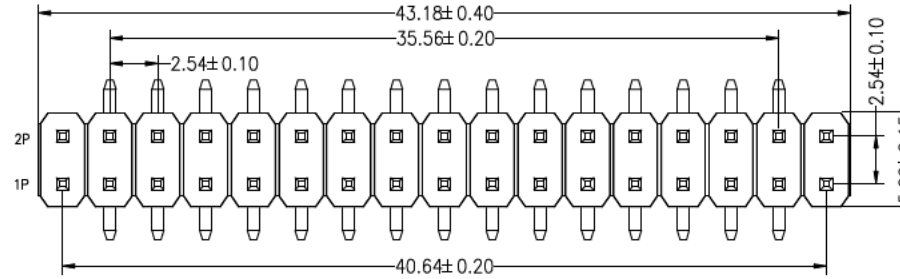
Rated Current:3.0AMP
 Contact Resistance:20mΩ Max
 Withstand Voltage:1000V AC/DC
 Insulation Resistance:1000MΩ Min
 Operation Temperature:-40°C to +105°C

Contact Material:Brass
 Contact Plating:Au Over Ni
 Insulator Material:Polyester(UL94V-0)
 Max.Processing Temp:
 (PA6T)260°C±5°C For 5~10 Second

Ordering Information

SM C02 2200 XX BD+S (D= E= A=)-packing

XX: Number of Poles -total
 BD+S: SMD and THT (first and last row)
 (D= E= A=) : ...fill in requested dimensions
 -packing : omitted ...bag
 A= Tray
 T= Tube



Recommended P.C.B Layout(Top Side)
 (PCB BOARD TOLERANCE±0.05)

Dimension antitheses list				
ITEM	E	D	S	
Standard	6.00	10.70	8.50	

OPERATION		DRAW	Jelly	08.06.2024	SCALE	FIT
X.X	±0.30				UNIT	mm
X.XX	±0.20	CHECK			SIZE	A4
X.XXX	±0.10				SHEET	1/1
Angle	±3°	APPROVE			PROJ.	
DIM	TOL					



PART NO. SM C02 2200 XX BD+S (D= E= A=)-packing
 TITLE: 2.54PH H2.5mm Dual Row SMT

A0	2024.06.08	NEW DRAWING	
REV	DATE	MODIFICATION DESCRIPTION	CHANGE